TOSHIBA Photocoupler Photorelay

TLP4197G

PBX

Telecommunication

Modem·FAX Cards, Modems In PC

Measurement Instrumentation

The TOSHIBA TLP4197G consists of an aluminum gallium arsenide infrared emitting diode optically coupled to a photo-MOSFET in a SOP, which is suitable for surface mount assembly.

The TLP4197GA is suitable for replacement of mechanical relays in many applications which require space savings.

• 6 pin SOP (2.54SOP6): 2.1 mm high, 2.54 mm pitch

• 1-form-B

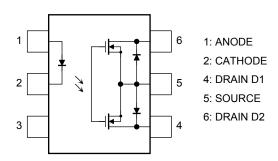
• Peak off-state voltage: 350 V (min)

Trigger LED current: 3 mA (max)
On-state current: 120 mA (max)

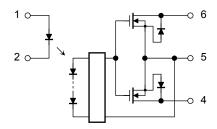
On-state resistance: 25 Ω (max)

• Isolation voltage: 1500 Vrms (min)

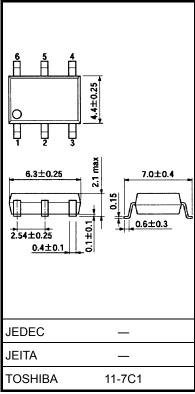
Pin Configuration (top view)



Schematic



Unit: mm



Weight: 0.13 g (typ.)

Absolute Maximum Ratings (Ta = 25°C)

Characteristics		Symbol	Rating	Unit		
	Forward current		l _F	50	mA	
	Forward current de (Ta ≧ 25°C)	erating	ΔI _F /°C	-0.5	mA/°C	
LED	Peak forward curre (100 μs pulse, 100		I _{FP}	1	Α	
	Reverse voltage		V_{R}	5	V	
	Junction temperat	ure	Tj	125	°C	
	Off-state output te	rminal voltage	Voff	350	V	
	On-state current	A connection		120		
		B connection	I _{ON}	120	mA	
ctor		C connection		240		
Detector	On-state current derating (Ta ≧ 25°C)	A connection		-1.2		
		B connection	Δl _{ON} /°C	-1.2	mA/°C	
		C connection		-2.4		
	Junction temperat	ure	Tj	125	°C	
Ope	Operating temperature range		T _{opr}	-40 to 85	°C	
Storage temperature range			T _{stg}	-55 to 125	°C	
Lead	soldering tempera	ture (10 s)	T _{sol}	260	°C	
	tion voltage 1 min, R.H. ≦ 60%) (Note 1)	BVS	1500	Vrms	

Note: Using continuously under heavy loads (e.g. the application of high temperature/current/voltage and the significant change in temperature, etc.) may cause this product to decrease in the reliability significantly even if the operating conditions (i.e. operating temperature/current/voltage, etc.) are within the absolute maximum ratings.

Please design the appropriate reliability upon reviewing the Toshiba Semiconductor Reliability Handbook ("Handling Precautions"/"Derating Concept and Methods") and individual reliability data (i.e. reliability test report and estimated failure rate, etc).

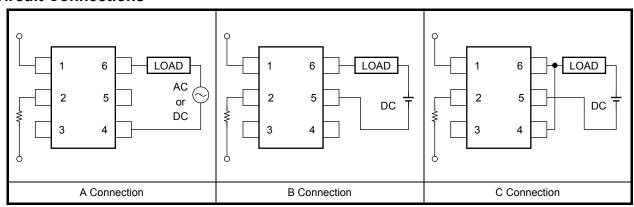
Note 1: Device considered a two-terminal device: LED side pins shorted together, and DETECTOR side pins and 6 shorted together.

Recommended Operating Conditions

Characteristics	Symbol	Min	Тур.	Max	Unit
Supply voltage	V_{DD}	_	_	280	V
Forward current	l _F	5	_	25	mA
On-state current	I _{ON}	_	_	120	mA
Operating temperature	T _{opr}	-20	_	65	°C

Note: Recommended operating conditions are given as a design guideline to obtain expected performance of the device. Additionally, each item is an independent guideline respectively. In developing designs using this product, please confirm specified characteristics shown in this document.

Circuit Connections



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Individual Electrical Characteristics (Ta = 25°C)

	Characteristics	Symbol	Test Condition	Min	Тур.	Max	Unit
	Forward voltage	V _F	I _F = 10 mA	1.0	1.15	1.3	V
LED	Reverse current	I _R	V _R = 5 V	_	_	10	μΑ
	Capacitance	C _T	V = 0, f = 1 MHz	_	30	_	pF
Detec- tor	Off-state current	loff	$V_{OFF} = 350 \text{ V}, I_F = 5 \text{ mA}$	_	_	1	μΑ
Det to	Capacitance	C _{OFF}	V = 0, f = 1 MHz, I _F = 5 mA	_		_	pF

Coupled Electrical Characteristics (Ta = 25°C)

Characteristics		Symbol	Test Condition	Min	Тур.	Max	Unit
Trigger LED current		I _{FC}	I _{OFF} = 10 μA	_	1	3	mA
Return LED current		I _{FT}	I _{ON} = 120 mA	0.1	_	_	mA
	A connection	R _{ON}	I _{ON} = 120 mA	_	15	25	
On-state resistance	B connection		I _{ON} = 120 mA	_	8	14	Ω
	C connection		I _{ON} = 240 mA	_	4	_	

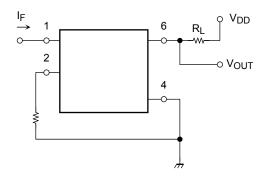
Isolation Characteristics (Ta = 25°C)

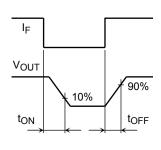
Characteristics	Symbol	Test Condition	Min	Тур.	Max	Unit
Capacitance input to output	CS	V _S = 0, f = 1 MHz	_	8.0	_	pF
Isolation resistance	R _S	V _S = 500 V, R.H. ≤ 60%	5×10^{10}	10 ¹⁴	_	Ω
	BV _S	AC, 1 min	1500	_	_	Vrms
Isolation voltage		AC, 1 s, in oil	_	3000	_	VIIIIS
		DC, 1 min, in oil	_	3000		Vdc

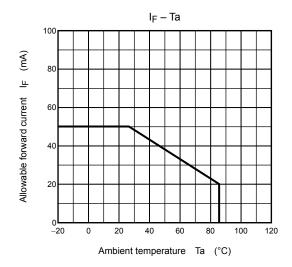
Switching Characteristics (Ta = 25°C)

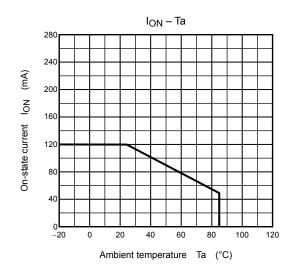
Characteristics	Symbol	Test Condition	Min	Тур.	Max	Unit
Turn-on time	t _{ON}	$R_L = 200 \Omega$ (Note 2)	_	_	1	ms
Turn-off time	toff	$V_{DD} = 20 \text{ V}, I_F = 5 \text{ mA}$	_	_	3	ms

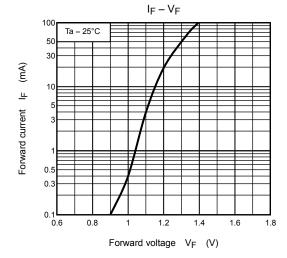
Note 2: Switching time test circuit

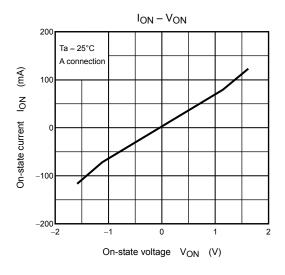


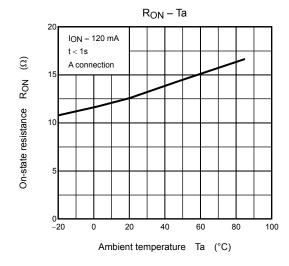


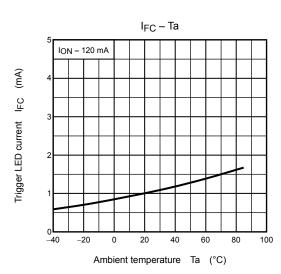




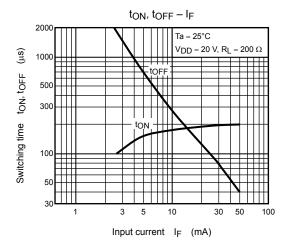


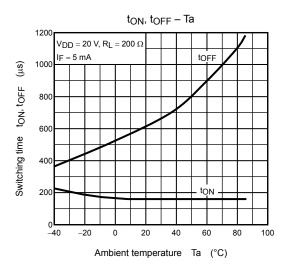


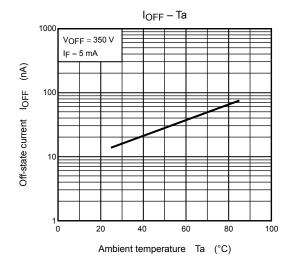




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RESTRICTIONS ON PRODUCT USE

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